

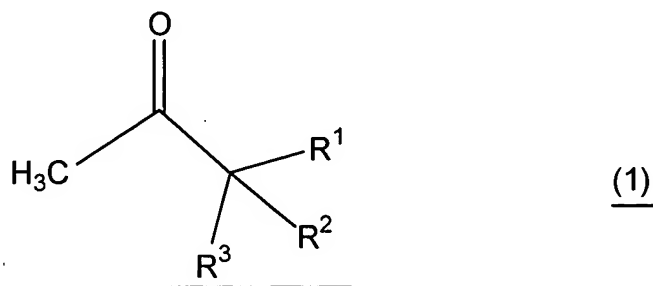
AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the application:

1-15. (Cancelled)

16. (Original) A method for producing a silicone compound having epoxy group, a ketimine group, and an alkoxysilyl group in its molecule characterized in that said compound is produced by heating and stirring an alkoxysilane having epoxy group in its molecule, an alkoxysilane having amino group in its molecule, and a ketone.

17. (Currently Amended) A method for producing a silicone compound according to claim 16 wherein said ketone is represented by [[said]] the following formula (1)[[.]]:



wherein R¹ is a member selected from the group consisting of alkyl groups containing 1 to 6 carbon atoms,

R² is methyl group or ethyl group, and

R³ is hydrogen atom, methyl group, or ethyl group.

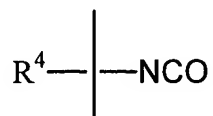
18. (Original) A silicone compound obtained by the production method according to claim 16.

19. (Currently Amended) A one-part, room temperature moisture curable resin composition comprising

a silicone compound obtained by the production method according to claim 16
[[or 17]]; and

an epoxy resin and/or a modified silicone having at least two hydrolyzable
alkoxysilyl groups in ~~[[it]]~~ its molecule.

20. (Withdrawn/Currently amended) A method for producing a ketimine compound
characterized in that said compound is produced by reacting a ketone with a ~~polyamide~~
polyamine, and then adding an isocyanate group-containing compound represented by
the following formula:



wherein R⁴ is an organic group (which may be a group containing O, S or N).

21. (Withdrawn/Currently amended) A method for producing a ketimine compound
according to claim 20 wherein said ketimine is synthesized from the ketone represented
by said formula (1) and the ~~polyamide~~ polyamine represented by said formula (2).

22. (Wtihadrawn/Currently amended) A method for producing a ketimine compound
characterized in that said compound is produced by reacting a ketone and a ~~polyamide~~
polyamine, and then adding a silane coupling agent as a dehydration agent.

23. (New) A one-part, room temperature moisture curable resin composition
comprising

a silicone compound obtained by the production method according to claim 17;
and

an epoxy resin and/or a modified silicone having at least two hydrolyzable alkoxysilyl groups in its molecule.